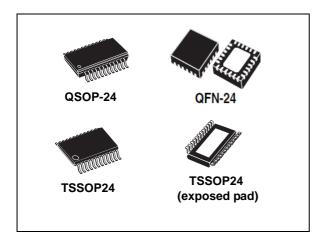
LED1642GW



16 channels LED driver with error detection current gain control and 12/16-bit PWM brightness control

Datasheet - production data



Features

- 16 constant current output channels
- Output current: from 3 mA to 40 mA
- Current programmable through external resistor
- 7-bit global current gain adjustment in two ranges
- 12/16-bit PWM grayscale brightness control
- Programmable output turn-on/off time
- Error detection mode (both open and shorted-LED)
- Programmable shorted-LED detection thresholds
- Auto power saving/auto-wakeup
- Selectable SDO synchronization on the CLK falling edge
- Gradual output delay (selectable)
- Supply voltage: 3 V to 5.5 V
- Thermal shutdown and overtemperature alert
- 30 MHz 4-wires interface
- 20 V current generator rated voltage

Applications

- Full color/monochrome large displays
- LED signage

Description

The LED1642GW is a monolithic, low voltage, low current power 16-bit shift register designed for LED panel displays. The LED1642GW guarantees 20 V output driving capability allowing the user to connect several LEDs in series. In the output stage, sixteen regulated current sources provide from 3 mA to 40 mA constant current to drive the LEDs. The current is programmed through an external resistor and can be adjusted by 7-bit current gain register in two subranges. The brightness can be adjusted separately for each channel through a 12/16-bit grayscale control.

A programmable turn-on and turn-off time (four different values are available) improves the system low noise generation performances.

In the LED1642GW is available the open/short error detection mode. The auto power shutdown and auto power-on feature (this feature is selectable) allow the device to save power without any external intervention.

Thermal management is equipped with overtemperature data alert and the output thermal shutdown (170 °C). The high clock frequency is up to 30 MHz and it makes the device suitable for high data rate transmission. A selectable gradual output delay reduces the inrush current whereas the selectable SDO synchronization feature works when the device is used in daisy chain configuration. The supply voltage range is between 3 V and 5.5 V.

Contents LED1642GW

Contents

1	Pin c	lescription	. 6
2	Abso	olute maximum ratings	. 7
3	Ther	mal characteristics	. 8
4	Elect	trical characteristics	. 8
5	Swite	ching characteristics	12
6	Simp	olified internal block diagram	15
	6.1	Equivalent circuits of inputs and outputs	15
7	Digit	al blocks	16
В	Conf	iguration register	18
	8.1	Gain control (from CFG 0 to 5) and current ranges (CFG- 6)	19
	8.2	Error detection mode (CFG-7)	21
	8.3	Error detection conditions	24
	8.4	Auto-wakeup/auto power shutdown (CFG-10)	24
	8.5	Programmable turn-on/turn-off time (CFG-11/12)	24
	8.6	SDO delay (CFG-13)	25
	8.7	Gradual output delay (CFG-14)	26
	8.8	PWM counter setting and brightness register (CFG-15)	27
9	Ther	mal flag	29
10	Drop	out voltage	30
11	Pack	age mechanical data	31



LED1642GW	Content

12	Packaging mechanical data	39
13	Ordering information	41
14	Revision history	42



List of tables LED1642GW

List of tables

Table 1.	Pin description	6
Table 2.	Absolute maximum ratings	7
Table 3.	Thermal characteristics	8
Table 4.	Electrical characteristics	8
Table 5.	Switching characteristics	12
Table 6.	Programmable TON/TOFF (output rise and fall time)	13
Table 7.	Digital key summary	16
Table 8.	Configuration register	18
Table 9.	Example of current ranges	20
Table 10.	Gain steps for the current range selected by REXT = 11 kW	20
Table 11.	Diagnostic thresholds	24
Table 12.	Minimum dropout voltage for some current values	30
Table 13.	QSOP-24 mechanical data	33
Table 14.	QFN-24 mechanical data	35
Table 15.	TSSOP24 mechanical data	36
Table 16.	TSSOP24 exposed pad mechanical data	38
Table 17.	TSSOP24 and TSSOP24 exposed pad tape and reel mechanical data	40
Table 18.	Ordering information	41
Table 19	Document revision history	42



LED1642GW List of figures

List of figures

Figure 1.	TSSOP24, TSSOP24EP, QSOP-24 pinout	6
Figure 2.	QFN-24 pinout	6
Figure 3.	Typical chip-to-chip accuracy	11
Figure 4.	Typical application schematic	11
Figure 5.	Timing for clock, serial in, serial out, latch enable and outputs	14
Figure 6.	LED1642GW simplified block diagram	15
Figure 7.	Input and output equivalent circuits	15
Figure 8.	Digital keys	
Figure 9.	Channel data and write switch	17
Figure 10.	Channel current vs. gain register value	21
Figure 11.	Error detection action sequence	22
Figure 12.	Error detection power-on timing	22
Figure 13.	Configuration register reading sequence	23
Figure 14.	Configuration register reading sequence (zoom)	23
Figure 15.	Configuration register reading sequence - SDO delay actives	23
Figure 16.	Configuration register reading sequence - SDO delay actives (zoom)	23
Figure 17.	Output TON (current rise time) CFG - 12 = CFG - 11 = 0	
Figure 18.	Output TOFF (current fall time) CFG -12 = CFG - 11 = 0	25
Figure 19.	Output TON (current rise time) CFG -12 = CFG - 11 = 1	
Figure 20.	Output TOFF (current fall time) CFG -12 = CFG - 11 = 1	25
Figure 21.	SDO delay	26
Figure 22.	Gradual output delay	27
Figure 23.	PWCLK counter and comparator	28
Figure 24.	Brightness register setting	28
Figure 25.	Thermal flag status	
Figure 26.	Typical channel dropout voltage vs. output current (VDD = 3.3 V)	30
Figure 27.	QSOP-24 package dimensions	32
Figure 28.	QFN-24 package dimensions	34
Figure 29.	TSSOP24 package dimensions	36
Figure 30.	TSSOP24 exposed pad dimensions	
Figure 31.	SSOP24 and TSSOP24 exposed pad tape and reel dimensions	39



Pin description LED1642GW

1 Pin description

Figure 1. TSSOP24, TSSOP24EP, QSOP-24 pinout

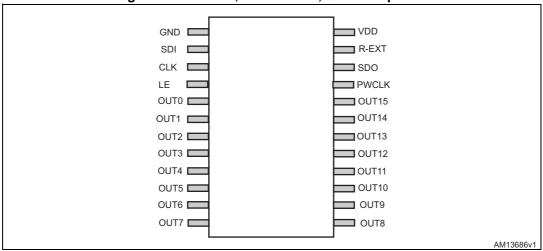


Figure 2. QFN-24 pinout

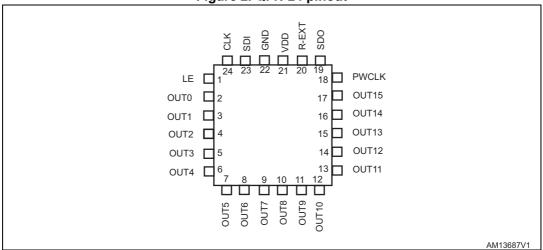


Table 1. Pin description

TSSOP24 TSSOP24EP QSOP-24	QFN-24	Symbol	Name and function
1	22	GND	Ground terminal
2	23	SDI	Serial data input terminal
3	24	CLK	Clock input terminal
4	1	LE	Latch input terminal
5-20	2-17	OUT0-OUT15	Output terminals
21	18	PWCLK	Clock input for PWM counter

TSSOP24 TSSOP24EP QFN-24 **Symbol** Name and function QSOP-24 SDO 22 19 Serial data output terminal Terminal for external resistor for constant current 23 20 R-EXT programming Supply voltage terminal 24 21 **VDD**

Table 1. Pin description (continued)

2 Absolute maximum ratings

Stressing the device above the ratings listed in the *Table 2* may cause the device permanent damage. Operating under conditions above those indicated in the operating section is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DD}	Supply voltage	0 to 7	V
V _{OUT}	Output voltage	-0.5 to 20	V
I _{OUT}	I _{OUT} Output current		mA
V _i	Input voltage	-0.4 to V _{DD} +0.4	V
I _{GND}	GND terminal current	1400	mA
ESD	Electrostatic discharge protection HBM human body model	±2	kV



Thermal characteristics LED1642GW

3 Thermal characteristics

Table 3. Thermal characteristics

Symbol	Parameter	Value	Unit	
T _a	Operative free-air temperature	Operative free-air temperature range ⁽¹⁾		
T _{OPR}	Operative junction temperatu	-40 to +125	°C	
T _{STG}	Storage ambient temperatur	-55 to +150		
		QFN-24	30	
В	Thermal resistance junction-ambient	TSSOP24	85	°C/W
$R_{thj-amb}$		TSSOP24EP ⁽²⁾	37.5	- C/VV
		QSOP-24	72	

This data must be considered in adequate power dissipation conditions, the junction temperature must be maintained below 125 °C.

4 Electrical characteristics

 V_{DD} = 3.3 V, T_{j} = 25 °C, unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V_{DD}	Supply voltage		3		5.5	
V _{OUT}	Output voltage	Out 0 - out 15	-	-	19	
V _{IH}	Input voltage		0.7 x V _{DD}	-	V_{DD}	V
V _{IL}	input voitage		GND	-	0.3 x V _{DD}	
V _{OL}	Serial data output voltage	V _{DD} = 3 to 5.5 V	-	-	0.4	
V _{OH}	(SDO)	I = +/- 1 mA	V _{DD} -0.4	-	-	
I _{Oleak}	Output leakage current	V _{OUT} = 19 V, all outputs OFF	-	-	0.5	μΑ
V	UVLO threshold (rising)			2.7	2.9	V
V_{uvlo}	UVLO threshold (falling)		2.2	2.3		V
Hy _{uvlo}	UVLO hysteresis			400		mV

^{2.} The exposed pad should be soldered directly to the PCB to get the thermal benefits.

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
^{Δl} oL1		$V_{OUT} = 0.1 \text{ V; } (I_{OUT} = 3 \text{ mA})$ $R_{EXT} = 11 \text{ k}\Omega$ CFG-0CFG-5= "000000" CFG-6 = "0"	-	-	±4	
Δl _{OL2}	Output current precision channel-to-channel (all outputs ON) ⁽¹⁾⁽²⁾	$V_{OUT} = 0.5 \text{ V; } (I_{OUT} = 20 \text{ mA})$ $R_{EXT} = 11 \text{ k}\Omega$ CFG-0CFG-5 = "011010" CFG-6 = "1"	-	-	±3	%
Δl _{OL3}		$V_{OUT} = 0.8 \text{ V; } (I_{OUT} = 36 \text{ mA})$ $R_{EXT} = 11 \text{ k}\Omega$ CFG-0CFG-5 = "1111111" CFG-6 = "1"	-	-	±3	
Δl _{OL2a}	Output current precision device-to-device (all outputs ON) ⁽¹⁾	$V_{OUT} = 0.5 \text{ V; } (I_{OUT} = 20 \text{ mA})$ $R_{EXT} = 1.1 \text{ k}\Omega$ CFG-0CFG-5 = "011010" CFG-6 = "1"	-	-	±6	%
%/dV _{OUT}	Output current vs. output voltage regulation (3)	V_{OUT} from 1 V to 3 V; (I_{OUT} = 36 mA) R_{EXT} = 11 k Ω CFG-0CFG-5 = "111111" CFG-6 = "1"	-	±0.1	1	
%/dV _{DD}	Output current vs. supply voltage regulation ⁽⁴⁾	V_{DD} from 3 V to 5.5 V V_{OUT} = 0.8 V; (I_{OUT} = 36 mA) R_{EXT} = 11 k Ω CFG-0CFG-5 = "111111" CFG-6 = "1"	-	±1	-	%/V
Rup	Pull-up resistor for PWCLK pin		400	500	600	
Rdw	Pull-down resistor for LE pin		400	500	600	ΚΩ
R _{EXT}	External current setup resistance				100	
I _{DD} (OFF1)	Supply current (OFF)	R_{EXT} = 11 k Ω OUT 0 to 15 = OFF CFG = default	-	-	6	
I _{DD} (ON1)	Supply current (ON)	$R_{EXT} = 11 \text{ k}\Omega; I_{OUT} = 20 \text{ mA}$ OUT 0 to 15 = ON CFG-0CFG-5 = "011010" CFG-6 = "1"	-		8	mA
I _{DD} (ON2)	Supply current (ON)	$R_{EXT} = 11 \text{ k}\Omega; I_{OUT} = 36 \text{ mA}$ OUT 0 to 15 = ON CFG-0CFG-5 = "1111111" CFG-6 = "1"	-		10	

Electrical characteristics LED1642GW

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _{DD} (auto OFF)	Supply current (auto OFF)	R_{EXT} = 11 k Ω ; OUT 0 to 15 = OFF CFG-0CFG-5 = "111111" CFG-6 = "1"	-	200	500	μА
T _{flg}	Thermal flag			150		
T _{sd}	Thermal shutdown ⁽⁵⁾			170		°C
T _{sd-hy}	Thermal shutdown hysteresis ⁽⁵⁾			15	20	

- 1. Tested with just one output loaded.
- 2. ((loutn loutavg1-15)/ loutavg1-15) x 100.

3.

$$\Delta(\%/V) = \frac{(\text{Ioutn @ Voutn} = 3.0V) - (\text{Ioutn @ Voutn} = 1.0V)}{(\text{Ioutn @ Voutn} = 1.0V)} \times \frac{100}{3-1}$$

4.

$$\Delta(\%/V) = \frac{(Ioutn @ V dd = 5.5V) - (Ioutn @ V dd = 3.0V)}{(Ioutn @ V dd = 3.0V)} \times \frac{100}{5.5 - 3}$$

5. Not tested, guaranteed by design.

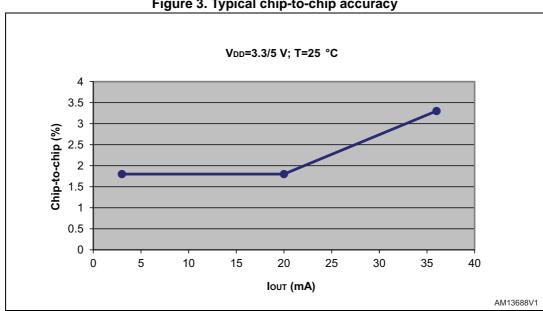
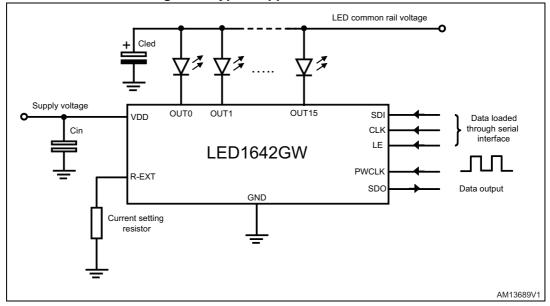


Figure 3. Typical chip-to-chip accuracy





5 Switching characteristics

 V_{DD} = 3.3 V, T_{j} = 25 °C, unless otherwise specified.

Table 5. Switching characteristics⁽¹⁾

Symbol	Para	meter	Conditions	Min.	Тур.	Max.	Unit
f _{clk}	Clock f	requency	Cascade operation	-	-	30	MHz
f _{pwclk}	PWclock	frequency		-	-	30	IVITZ
tr _(SDO)	SDO r	ise time	R_{EXT} = 11 k Ω ; I_{OUT} = 20 mA V_{OUT} = 0.8 V	-	5	-	
tf _(SDO)	SDO	fall time	VIH = V_{DD} ; VIL = GND RL = 3.3 KΩ; CL = 10 pF CFG-0CFG-5 = "011010" CFG-6 = "1"	-	5	-	
tPLHLE	LE - OUTn ⁽²⁾	Propagation delay		-	200	-	
tPLH	CLK - SDO CFG-13 = '0'	time ("L to "H")		8	15	25	
tPHLLE	LE - OUTn ⁽²⁾	Propagation delay		-	100	-	
tPHL	CLK - SDO CFG-13 = '0'	time ("H" to "L")		8	15	25	ns
tw(CLK)	CLK	Pulse width	R_{EXT} = 11 kΩ; I_{OUT} = 20 mA	20	-	-	
t _W (PWCLK)	PWCLK		$V_{OUT} = 0.8 \text{ V}$ VIH = V_{DD} ; VIL = GND	20	-	-	
tw(L)	LE		RL = 50Ω ; CL = $10 pF$	20	-	-	
t _{gr-d}	Gradual de	elay ch-to-ch	CFG-0CFG-5 = "011010" CFG-6 = "1"		10		
t _{su(L)}	Setup ti	me for LE	CFG-6 = "1"	5	-	-	
t _{h(L)}	Hold tir	ne for LE		5	-	1	
t _{su(D)}	Setup tir	me for SDI		5	-	1	
t _{h(D)}	Hold tim	ne for SDI		10	-	-	
tclkr ⁽³⁾	Maximum (CLK rise time		-	-	5	116
tclkf ⁽³⁾	Maximum	CLK fall time		-	-	5	μs
I _{out-ov}	Output current t	turn-on overshoot	V _{OUT} = 0.6 to 3 V CL = 10 pF; I _{OUT} = 3 to 36 mA	-	-	10	%
t _{n-err}		or detection utput ON time		-	-	1	μs



Table 5. Switching characteristics⁽¹⁾

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
t _{shutdown}	Auto power shutdown time (auto OFF)	From LE falling edge to R _{EXT} voltage reference at -10%	-	100	-	ns
t _{wakeup}	Auto-wakeup	From LE falling edge to R _{EXT} voltage reference at 90%	-	3	-	μs

- 1. Not tested in production. All table limits are guaranteed by design.
- 2. CFG -11= 0 and CFG -12 = 0 (output tr = 30 ns; output tf = 20 ns); CFG-14=1 (no output gradual delay).
- 3. If devices are connected in cascade and tclkr or tclkf is large, it may be critical to achieve the timing required for data transfer between two cascaded devices.

Table 6. Programmable T_{ON}/T_{OFF} (output rise and fall time)

Configuration bits	Conditions	Typ. (20% to 80%) Turn-on Turn-off		Unit
(CFG-12 - CFG-11)	Conditions			Oill
0 - 0	$R_{EXT} = 11 \text{ k}\Omega; I_{OUT} = 20 \text{ mA}$	30 ns	20 ns	
0 - 1	$V_{OUT} = 0.8 \text{ V}$	100 ns	40 ns	
1 - 0	VIH= V_{DD} ; VIL= GND RL = 50 Ω ; CL=10pF	140 ns	80 ns	ns
1 - 1	CFG-0CFG-5="011010" CFG-6 = "1"	180 ns	150 ns	



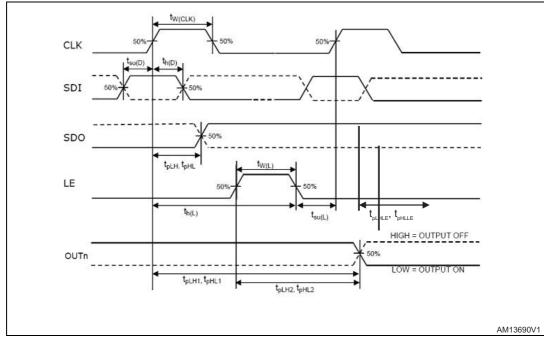


Figure 5. Timing for clock, serial in, serial out, latch enable and outputs

The correct sampling of the data depends on the stability of the data at SDI on the rising edge of the clock signal and it is assured by a proper data setup and hold time ($t_{SU(D)}$) and $t_{h(D)}$), as shown in *Figure 5*. The same figure shows the propagation delay from CLK to SDO (t_{PLH}/t_{PHL}). *Figure 5* describes also the minimum duration of CLK, LE pulses ($t_{W(CLK)}$) and $t_{W(L)}$ respectively and the propagation delay from LE to OUT_n (t_{PLHLE} and t_{PHLLE}) in the hypothesis that all channels have already been enabled by PWM counter.



6 Simplified internal block diagram

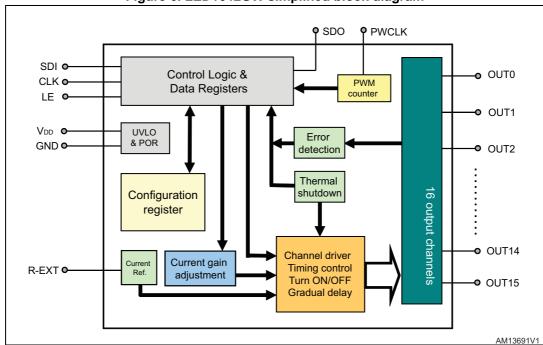


Figure 6. LED1642GW simplified block diagram

6.1 Equivalent circuits of inputs and outputs

LE and PWCLK input terminals have pull-down and pull-up connection respectively. CLK and SDI must be connected to the external circuit to fix the logic level.

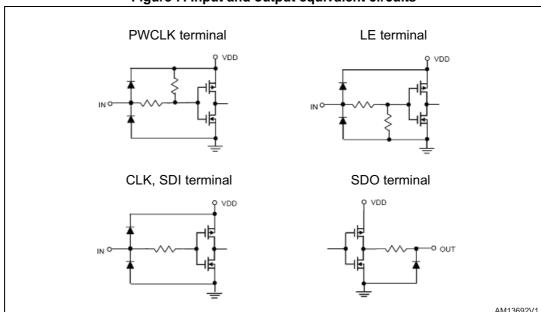


Figure 7. Input and output equivalent circuits

Digital blocks LED1642GW

7 Digital blocks

The data input arrives through the serial Interface at each CLK rising edge. The LE signal is used to latch the loaded data and also to address data loading to the appropriate register, thermal flag reading and error detection. The access to the different registers or functions of the device (configuration register, brightness register or current gain, error detection, etc.) is achieved by using different digital keys, defined as a number of CLK pulses during which the LE signal is asserted. The available digital keys are listed in *Table 7* and *Figure 8*. A typical channel data input is shown in *Figure 9*.

Table 7. Digital key summary

Number	# CLK rising edge when the LE is "1"	Command description
1	1 – 2	Write switch (to turn on/off output channels)
2	3 – 4	Brightness data latch
3	5 – 6	Brightness global latch
4	7	Write configuration register
5	8	Read configuration register
6	9	Start open error detection mode
7	10	Start short error detection mode
8	11	Start combined error detection mode
9	12	End error detection mode
10	13	Thermal error reading
11	14	Reserved
12	15	Reserved

LED1642GW Digital blocks

Figure 8. Digital keys

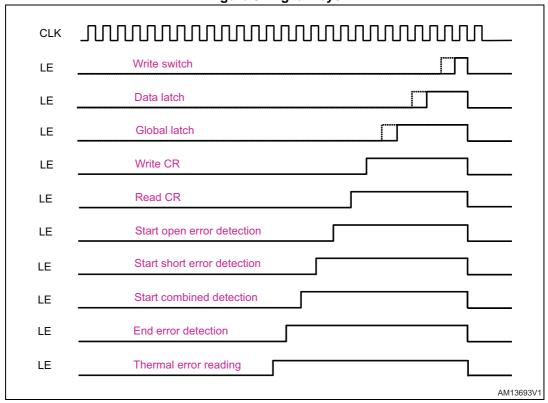
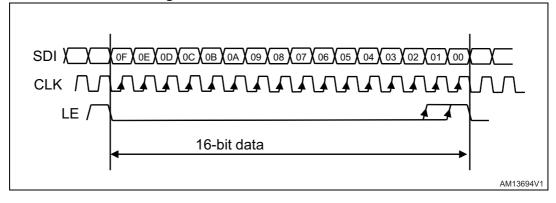


Figure 9. Channel data and write switch



8 Configuration register

The configuration register is used to enable or disable some device features, to program some parameters and to change other settings. The access to this register (read or write) is managed to find a description for each bit as described in *Table 8*. The default value of the configuration register (when the device is switched on or after a reset) is "0" for all bits. To change anything in the configuration register, a 16-bit digital word must be sent (CFG - 0 represents LSB, CFG -15 the MSB).

Table 8. Configuration register

Bit	Definition	R/W		Desc	ription			Default						
CFG-0								0						
CFG-1	1													
CFG-2	Current gain	R/W	6-bit DAC allows adjusting the device output current in 64				the device output current in 64							
CFG-3	adjustment	K/VV	steps for each range	teps for each range (defined by CFG-6)			0							
CFG-4	1					0								
CFG-5								0						
CFG-6	Current range	R/W	_	'0" low current range '1" high current range			0							
CFG-7	Error detection mode	R/W	"0" normal mode "1" reserved mode			0								
		sho thre			CFG-9	CFG-8	Th. volt.							
CFG-8	Shorted-LED		W Programmable out	Programmable output		0	0	1.8 V	0					
	detection			shorted-LED detection	0	1	2.5 V							
CFC 0	thresholds			R/W	DAM	DAM	thresholds		1	0	3 V	0		
CFG-9		K/VV	1	1	1	3.5 V	0							
CFG-10	Auto OFF shutdown	R/W	"0" device always O		e (auto O	FF)	•	0						
				CFG-12	CFG-11	Turn-on	Turn-off							
CFG-11		R/W	Programmable	0	0	30 ns	20 ns	0						
	Output turn- on/off time		output rise and fall	0	1	100 ns	40 ns							
050.40		D/\\	time (20% to 80%)	1	0	140 ns	80 ns							
CFG-12		R/W		1	1	180 ns	150 ns	0						
CFG-13	SDO delay	R/W	If "0" no delay is pre If "1" the data are sh the falling edge of th	nifted out a	ind they a	re synchro	onized with	0						

Bit	Definition	R/W	Description	Default
CFG-14	Gradual output delay	R/W	"0" a progressive delay is applied to output (10 ns per channel) "1" no delay is applied to output	0
CFG-15	12/16 PWM counter	R/W	"0" to select 16-bit brightness register (65536 grayscale rightness steps). "1" to select 12-bit brightness register (4096 grayscale brightness steps)	0

Table 8. Configuration register (continued)

8.1 Gain control (from CFG 0 to 5) and current ranges (CFG- 6)

The LED current can be programmed using an external resistor connected to GND from R_{EXT} pin and can be fixed using the dedicated bits of the configuration register (from CFG - 0 to CFG - 5 bits define the gain, while CFG - 6 bit defines the current range within the which the gain can be adjusted). The device can regulate the current up to 36 mA and down to 0.5 mA. The accuracy of the LED current depends on the selected range and it is guaranteed in the ranges indicated in the static electrical characteristics only (see *Table 3* and *9*). When the device is switched on, the selected current range and the resistor connected to the R_{EXT} pin fix the default LED current:

$$I_{\mathit{OL_default}} = \frac{V_{\mathit{REF}}}{R_{\mathit{FXT}}} \cdot K$$

Where V_{REF} =1.23 V is the voltage of the R_{EXT} pin and K is the mirroring current ratio, whose value depends on the selected current range:

- K = 28 with low current range selected (CFG 6 = "0")
- K = 80 with high current range selected (CFG 6 = "1")

The relation between the programmed current and the current gain settings is the following:

$$I_{OL} = (I_{OL_default} + G \cdot \Delta I_{step})$$

where G is the current gain value (decimal value) defined by the dedicated bits of the current gain register. The current gain is managed by 6-bits of the configuration register (CFG - 0 to CFG - 5, CFG - 0 is LSB and CFG - 5 is MSB) and can be adjusted within two ranges (selectable through the bit CFG - 6) over 64 steps. The width of each step depends on the default current ($I_{ol_default}$) as well as the selected R_{EXT} . Finally, each step is as follows:



$$\Delta I_{step} = \frac{I_{OL_default}}{21}$$

The *Table 9* shows an example of the current setting with an external resistance (R_{EXT}) = 11 KO:

Table 3. Example of current ranges						
	R _{EXT} [KΩ]	CFG-6	CFG-0 to CFG-5	LED current ⁽¹⁾ [mA]	Accuracy	
Low range	11	0	000000	3.1 mA	± 4% ch-to-ch	
Low range	11	0	111111	12.5 mA	_	
⊔igh rango	11	1	000000	8.9 mA	_	
High range	11	1	011010	20 mA	± 3% ch-to-ch	

Table 9. Example of current ranges

The *Table 10* shows an example of current setting and gain control with $R_{EXT} = 11 \text{ k}\Omega$, see also *Figure 10*.

	. CAI				
	CFG-6	CFG(0 to 5)	LED current ⁽¹⁾ [mA]		
	0	000000	3.131		
Low rango	0	000001	3.280		
Low range					
	0	111111	12.524		
High range	1	000000	8.945		
	1	000001	9.371		
	1	111111	35.78		

Table 10. Gain steps for the current range selected by R_{EXT} = 11 k Ω

The external programming resistance must be connected as close as possible to the related device pins (R_{EXT} and GND) to reduce as minimum as possible the routing length and prevent reference noise injection and electromagnetic interferences. Moreover, a direct connection to the device GND pin reduces the possible output current variation when the total device ground current changes (load effect).

577

^{1.} The indicated values may be slightly different on the current device.

 $^{1. \}quad \text{The indicated values may be slightly different on the current device}.$

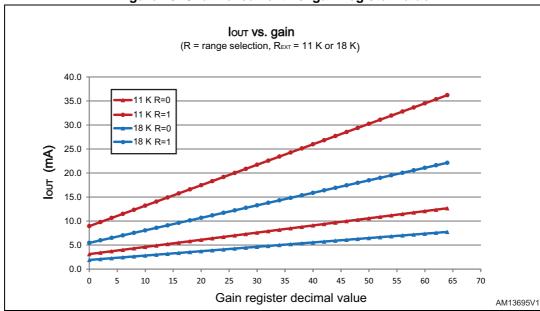


Figure 10. Channel current vs. gain register value

8.2 Error detection mode (CFG-7)

Stopping the normal activity of the display and turning on all driver channels allows the error detection to be performed and failed LED or display defects to be checked.

The error detection is active when the CFG -7 bit of the configuration register is "0". The diagnostics is performed as shown in *Figure 11*:

- The LED has to be selected turning on the relative channel on the switch register (powering on or off the output channels); the brightness register value for this channel cannot be zero.
- The normal error detection has to be selected in the configuration register (CFG-7= "0"). The appropriate digital key to choose the type of detection (open, short or combined) must be sent (see *Table 7*).
- After the error detection starts, the channel under testing has to be turned on at least 1 μs (the LED is at the nominal current). Please note that, the output power-on depends on PWCLK signal and in several applications this signal is not synchronized with the serial interface clock (CLK pin). Therefore, to be sure that, between the detection start and the detection end, the output power-on is 1 μs and moreover, that last power-on, in the interval, starts at least 0.5 μs before the detection end pattern (see *Figure 12*), it is suggested that the error detection should be performed just after the device startup (brightness counter reset) with all channels ON, before applying PWCLK signal.
- The result of the detection ("0" indicates a fault condition) is shifted out SDO, in 16 clock pulses after the "detection end command" is provided, first output bit represents channel 15 (error data can be read in a way similar to configuration register data reading as shown on *Figure 13*, *14*, *15* and *16*).

Please note that (with SDO delay off) output 15 detection result will be available just after 1st clock pulse rising edge, so it can be sampled on the rising edge of second clock pulse. In the same way output 0 detection result will be available just after 16th clock pulse rising edge, so it can be sampled on the rising edge of 17th CLK pulse.



Figure 11. Error detection action sequence

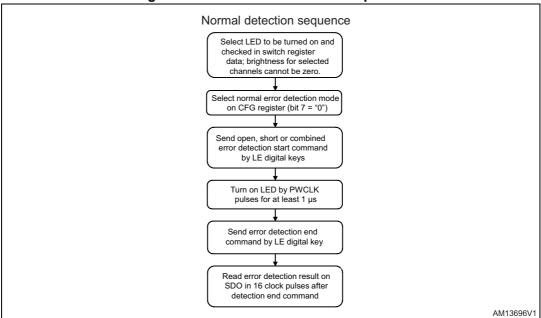


Figure 12. Error detection power-on timing

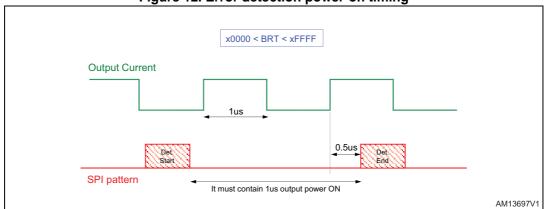


Figure 13. Configuration register reading sequence

Figure 14. Configuration register reading sequence (zoom)

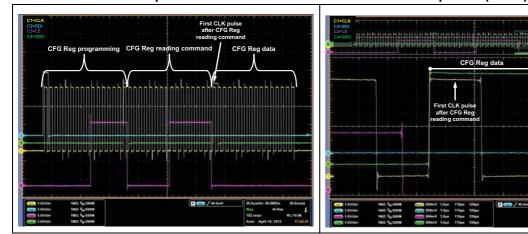
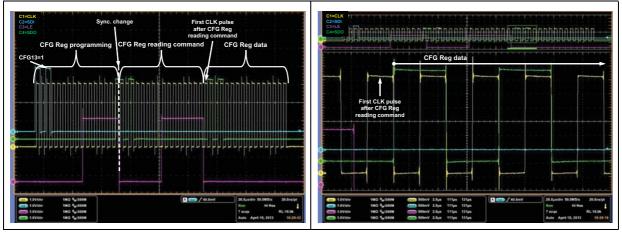


Figure 15. Configuration register reading sequence - SDO delay actives

Figure 16. Configuration register reading sequence - SDO delay actives (zoom)





8.3 Error detection conditions

During the error detection phases for each channel, the following checks have to be performed:

- The output current in open detection mode (digital key: 9 CLK rising edges when LE is "1")
- The output voltage in short detection (digital key: 10 CLK rising edges when LE is "1")
- Both parameters (output voltage and current) in combined error detection mode (digital key: 11 CLK rising edges when LE is "1").

The thresholds for the error diagnostics are listed in *Table 11*:

Error dete	ction	Checked	CFG-9	CFG-8		Thresholds (V)		
modes		malfunction	Cru-9	CFG-6	Min.	n. Typ.		
Open detection	mode	Open line or output short to GND	х	х	-	I _{OUT} ≤ 0.5 x I _{OUT} programmed	-	
		pec		0	0	1.15	V _{OUT} ≥ 1.8	2.05
Short			0	1	2.25	$V_{OUT} \ge 2.5$	2.75	
detection E	to V-LED	1	0	2.75	$V_{OUT} \ge 3.0$	3.25		
)		1	1	3.25	V _{OUT} ≥ 3.5	3.80	

Table 11. Diagnostic thresholds

8.4 Auto-wakeup/auto power shutdown (CFG-10)

This feature reduces the power consumption when all outputs are OFF. It is active when the CFG -10 bit of configuration register is "1". The auto power shutdown (auto OFF) starts when the data latched is "0" for all channels, and device is active again (wakeup) at the first latched data string including at least one bit = "1" (at least one channel ON). Timings for shutdown and wakeup are present in the dynamics feature table. While the auto power shutdown is active, the device ignores any other command except the channel power-on.

8.5 Programmable turn-on/turn-off time (CFG-11/12)

The device gives the possibility to program the turn-on and turn-off time of the current generators. Four different values can be selected using CFG -12 and CFG-11 bits of the configuration register (see *Table 8*) to fit the application requirements: 30/20 ns (00), 100/40 ns (01), 140/80 ns (10) and 180/150 ns (11). The selected value refers to T_{ON} (current rise time) and T_{OFF} (current fall time).

24/43 DocID024395 Rev 5

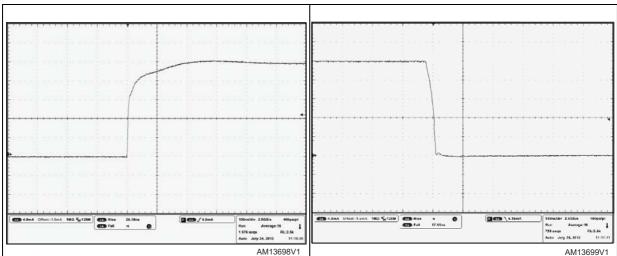
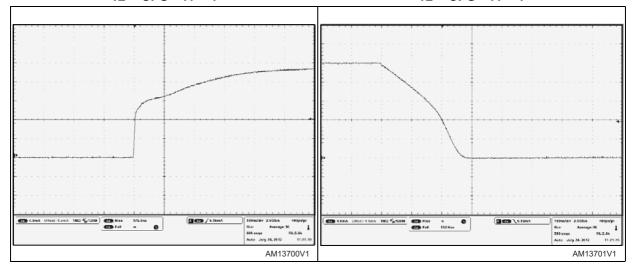


Figure 19. Output T_{ON} (current rise time) CFG - Figure 20. Output T_{OFF} (current fall time) CFG - 12 = CFG - 11 = 1



8.6 SDO delay (CFG-13)

Usually in SDO terminal, data are shifted out the rising edge of CLK signal (with a propagation delay of about 15 ns - signal (a) in *Figure 21*). The device has the possibility to shift data out the falling edge of the CLK signal (with few ns of propagation delay - signal (b) in *Figure 21*). This feature is active when CFG -13 bit of the configuration register is "1". Default setting for this bit is "0" hence the SDO delay is not activated by default. This feature is particularly useful when some devices are connected in daisy chain configuration with mismatched propagation delays, between CLK and SDO data path (board routing).

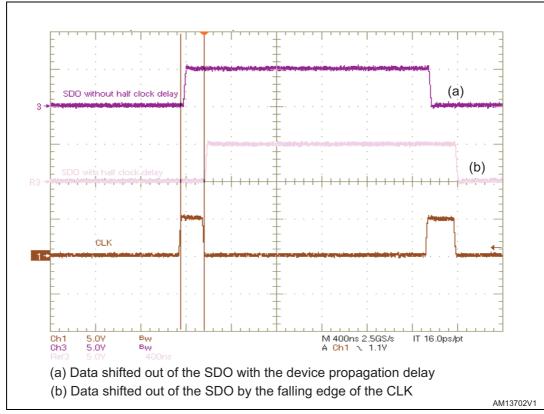


Figure 21. SDO delay

8.7 Gradual output delay (CFG-14)

The gradual output delay consists of turning on gradually the current generators avoiding to turn on all channels at the same time.

When PWM counter enables the device channels, the outputs can be turned on simultaneously or with a progressive delay. Thanks to configuration register CFG -14 bit, the user can decide to put a delay among outputs (10 ns from each channel to the next one, around 150 ns between first and last channel). The typical output timing is shown in *Figure 22*. This feature prevents the inrush current and reduces the bypass capacitor value.



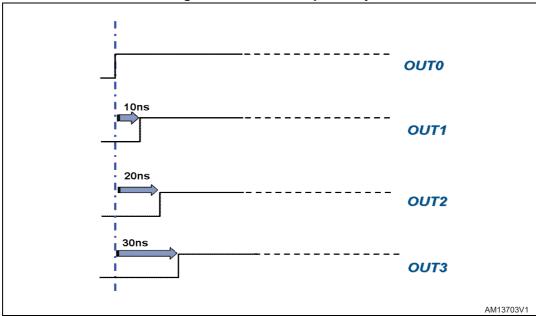


Figure 22. Gradual output delay

8.8 PWM counter setting and brightness register (CFG-15)

The brightness of each channel can be adjusted through a 12/16-bit PWM grayscale brightness control according to the PWM counter selection (configuration register CFG -15 bit). Brightness data is loaded by the SDI pin in a 16-bit shift register. Once 16-bit has been loaded (first input bit of brightness word is MSB, 16th bit is LSB), the digital word is moved to the corresponding temporary buffer (first word is the brightness of channel 15, the last one is for channel 0) using the appropriate key shown in *Table 7* ("data latch"). One "data latch" key must follow each 16-bit brightness word except the last one. When the last brightness word is loaded (channel 0 brightness data), the key indicated as "global latch" in *Table 7* must be used. This action moves the word from the shift register to the temporary buffer through the OUT0 and, at the same time, transfers all data of the 16 temporary buffers (16 x16-bit string) to the corresponding brightness registers (see also *Figure 28*).

The PWM signals are generated by comparing the content of the brightness registers to a 16-bit or 12-bit counter, according to the CFG-15 bit status. The counter's clock source is provided to the PWCLK pin. In case of selection of 12-bit PWM counter, the four most significant bits of each brightness data word are ignored. However, each of sixteen brightness data words must be 16-bit long. The brightness register default value is "0", unless this value is changed, the LED brightness is minimum. *Figure 27* shows this function in the schematic.

PWCLK must be a square wave signal, duty cycle is not important but the minimum width has to be above 20 ns, max. frequency has to be 30 MHz (pay attention the minimum output ON time). Just after the device startup (brightness counter reset), before applying PWCLK signal, all channels are in power-on condition if the brightness register values are not zeroed.

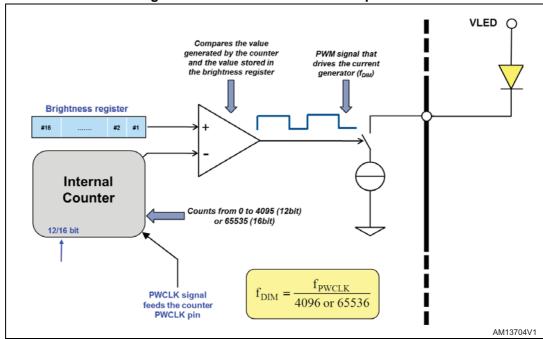
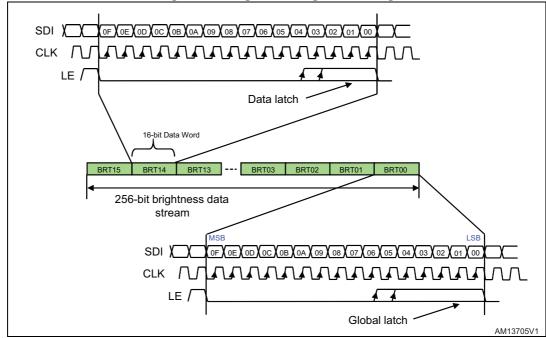


Figure 23. PWCLK counter and comparator







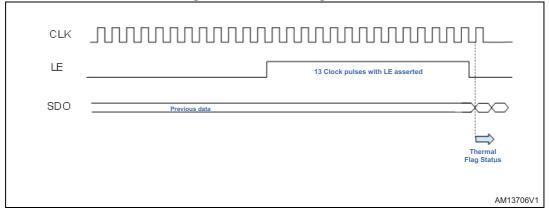
LED1642GW Thermal flag

9 Thermal flag

The device has a thermal control logic providing a flag status when the internal temperature exceeds 150 °C (if temperature increases over 170 °C a thermal shutdown protects the device). This status can be read running the digital key "thermal error reading", holding the LE high for 13 CLK rising edges (see *Figure 25*). If thermal alert is asserted, a 16-bit string = "1" is sent by SDO. The error data is uploaded into EDR register and this error notification is ready to be streamed through SDO to next 16 CLK rising edges. Hence, thermal flag status can be:

Device temperature	SDO		
under 150 °C	"0000 0000 0000 0000"		
over 150 °C	"1111 1111 1111"		

Figure 25. Thermal flag status



Dropout voltage LED1642GW

10 **Dropout voltage**

In order to correctly regulate the channel current, a minimum output voltage (V_{DROP}) across each current generator must be guaranteed.

The Figure 26 and Table 12 show the minimum V_{DROP} related to the regulated current; these measurements have been recorded with just one output ON. When more than one output is active the drop voltage increases. At 36 mA per channel, the minimum output voltage must be increased about 200 mV.

A V_{DROP}, lower than the minimum recommended, implies the regulation of a current lower than the expected one. However an excess of V_{DROP} increases the power dissipation.

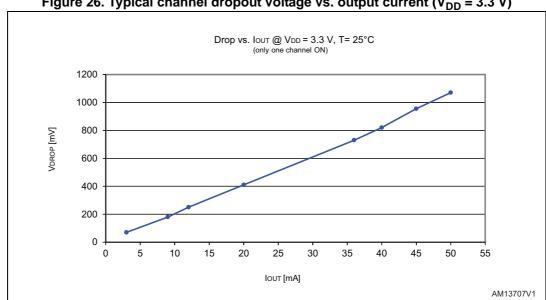


Figure 26. Typical channel dropout voltage vs. output current ($V_{DD} = 3.3 \text{ V}$)

Table 12. Minimum dropout voltage for some current values

Output current [mA]	Minimum V _{DROP} @ V _{DD} = 3.3 V [mV]
3	70
9	180
12	250
20	410
36	730
40	820
45	955
50	1070

11 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



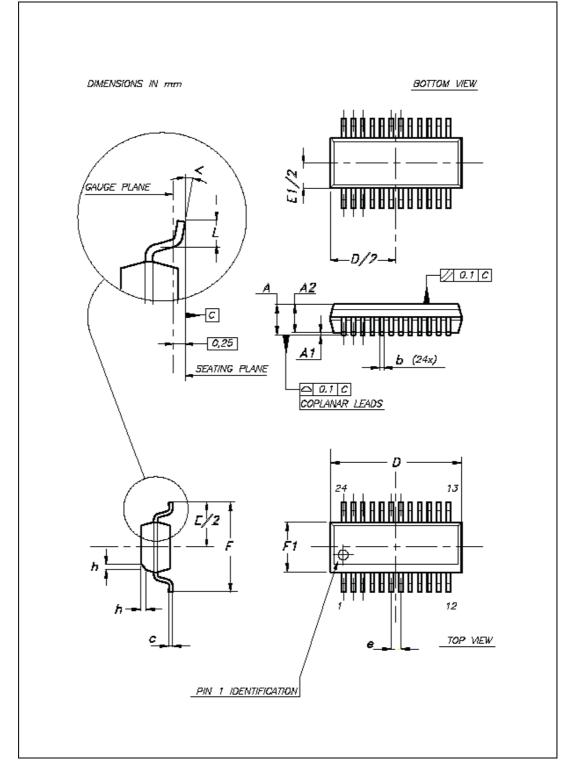


Figure 27. QSOP-24 package dimensions

577

Table 13. QSOP-24 mechanical data

Dim.		mm	
	Min.	Тур.	Max.
А	1.54	1.62	1.73
A1	0.1	0.15	0.25
A2		1.47	
b	0.31	0.2	
С	0.254	0.17	
D	8.56	8.66	8.76
E	5.8	6	6.2
E1	3.8	3.91	4.01
е		0.635	
L	0.4	0.635	0.89
h	0.25	0.33	0.41
<	8°	0°	



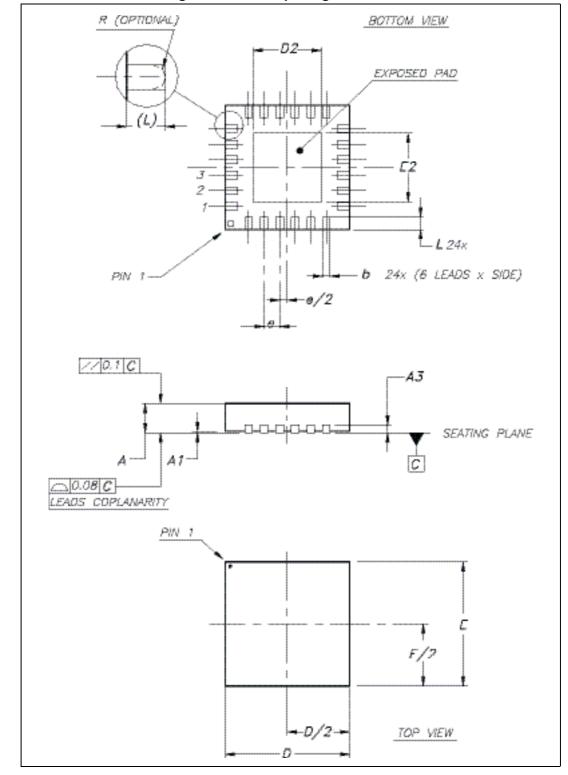


Figure 28. QFN-24 package dimensions

57

Table 14. QFN-24 mechanical data

Dim.		mm	
Dilli.	Min.	Тур.	Max.
А	0.80	0.90	1.00
A1	0	0.02	0.05
А3		0.20	
b	0.18	0.25	0.30
D	3.85	4.00	4.15
D2	2.00	2.15	2.25
Е	3.85	4.00	4.15
E2	2.00	2.15	2.25
е		0.50	
L	0.30	0.40	0.50



A A2
A1 b e C

PIN 1 IDENTIFICATION

1

7047476B

Figure 29. TSSOP24 package dimensions

Table 15. TSSOP24 mechanical data

Dim.	mm		
	Min.	Тур.	Max.
Α			1.1
A1	0.05		0.15
A2		0.9	
b	0.19		0.30
С	0.09		0.20
D	7.7		7.9
E	4.3		4.5
е		0.65 BSC	
Н	6.25		6.5
K	0°		8°
L	0.50		0.70

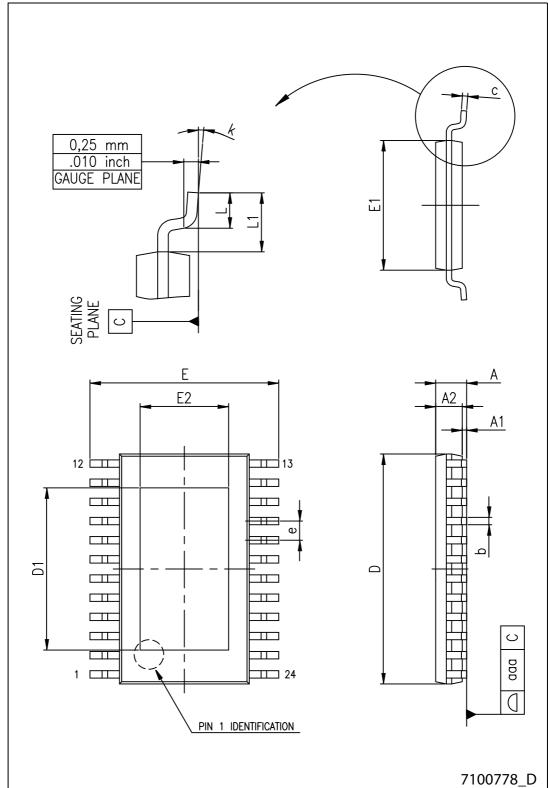


Figure 30. TSSOP24 exposed pad dimensions

Table 16. TSSOP24 exposed pad mechanical data

Dim.	mm		
	Min.	Тур.	Max.
А			1.20
A1			0.15
A2	0.80	1.00	1.05
b	0.19		0.30
С	0.09		0.20
D	7.70	7.80	7.90
D1	4.80	5.00	5.20
E	6.20	6.40	6.60
E1	4.30	4.40	4.50
E2	3.00	3.20	3.40
е		0.65	
L	0.45	0.60	0.75
L1		1.00	
k	0		8
aaa			0.10

12 Packaging mechanical data

A Po Note: Drawing not in scale

Figure 31. SSOP24 and TSSOP24 exposed pad tape and reel dimensions

Table 17. TSSOP24 and TSSOP24 exposed pad tape and reel mechanical data

Dim.	mm		
	Min.	Тур.	Max.
Α		-	330
С	12.8	-	13.2
D	20.2	-	
N	60	-	
Т		-	22.4
Ao	6.8	-	7
Во	8.2	-	8.4
Ko	1.7	-	1.9
Po	3.9	-	4.1
Р	11.9	-	12.1

13 Ordering information

Table 18. Ordering information

Order code	Package	Packaging
LED1642GWPTR	QSOP-24	2500 parts per reel
LED1642GWQTR	QFN-24	4000 parts per reel
LED1642GWTTR	TSSOP24	2500 parts per reel
LED1642GWXTTR	TSSOP24 exposed pad	2500 parts per reel

Revision history LED1642GW

14 Revision history

Table 19. Document revision history

Date	Revision	Changes
03-May-2013	1	Initial release.
06-Jun-2013	2	Updated Table 2: Absolute maximum ratings, Figure 10: Channel current vs. gain register value and Section 8.2: Error detection mode (CFG-7). Added Figure 13, 14, 15 and 16. Minor text changes.
19-Aug-2013	3	Updated the Title, the Features and the Description. Modified Table 4: Electrical characteristics, Updated Table 9: Example of current ranges, Table 10: Gain steps for the current range selected by REXT = 11 kW, Section 8.2: Error detection mode (CFG-7), Section 8.8: PWM counter setting and brightness register (CFG-15).
18-Mar-2014	4	Added footnote 1 in <i>Table 5: Switching characteristics</i> and footnote 5 in <i>Table 4: Electrical characteristics</i> .
16-Jun-2014	5	Updated <i>Table 16: TSSOP24 exposed pad mechanical data</i> . Minor text changes.

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2014 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

